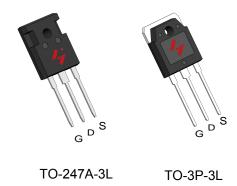


#### N-Channel Enhancement Mode MOSFET

### **Features**

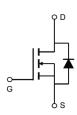
- 80V/170A  $R_{DS(ON)} = 3.6 \text{ m}\Omega \text{ (typ.)} @ V_{GS} = 10V$
- 100% avalanche tested
- Reliable and Rugged
- Lead Free and Green Devices Available (RoHS Compliant)

### **Pin Description**



### **Applications**

Power Management for Inverter Systems.



N Channel MOSFET

## Ordering and Marking Information



Package Code

W: TO-247A-3L A: TO-3P-3L

Assembly Material

Date Code YYXXX WW G: Lead Free Device

Note: HUAYI lead -free products contain molding compounds/die attach materials and 100% matte tin plate Termination finish; which are fully compliant with RoHS. HUAYI lead -free products meet or exceed the lead-Free requirements of IPC/JEDEC J-STD-020 for MSL classification at lead-free peak reflow temperature. HUAYI defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

HUAYI reserves the right to make changes, corrections, enhancements, modifications, and improvements to this pr-oduct and/or to this document at any time without notice.



# **Absolute Maximum Ratings**

| Symbol           | Parameter   | Rating                              | Unit       |        |
|------------------|---|-------------------------------------|------------|--------|
| Common           | Ratings (T <sub>C</sub> =25°C Unless Otherwise Noted) |                                     | •          |        |
| V <sub>DSS</sub> | Drain-Source Voltage                                  |                                     | 80         | V      |
| V <sub>GSS</sub> | Gate-Source Voltage                                   |                                     | ±25        | ☐      |
| TJ               | Maximum Junction Temperature                          |                                     | 175        | °C     |
| T <sub>STG</sub> | Storage Temperature Range                             |                                     | -55 to 175 | °C     |
| Is               | Diode Continuous Forward Current                      | T <sub>C</sub> =25°C                | 170        | А      |
| Mounted (        | on Large Heat Sink                                    | •                                   | •          |        |
| I <sub>DM</sub>  | Pulsed Drain Current *                                | T <sub>C</sub> =25°C                | 680**      | А      |
|                  | Continuous Drain Current                              | T <sub>C</sub> =25°C                | 170        | A      |
| l <sub>D</sub>   | Continuous Drain Current                              | T <sub>C</sub> =100°C               | 126        |        |
| В                | Maximum Dowar Discipation                             | T <sub>C</sub> =25°C                | 348        | W      |
| P <sub>D</sub>   | Maximum Power Dissipation                             | T <sub>C</sub> =100°C               | 174        |        |
| $R_{\theta JC}$  | Thermal Resistance-Junction to Case                   | Thermal Resistance-Junction to Case |            | °C/\/  |
| $R_{\theta JA}$  | Thermal Resistance-Junction to Ambient                |                                     | 40         | - °C/W |
| Avalanch         | e Ratings   |                                     | -          | -      |
| E <sub>AS</sub>  | Avalanche Energy, Single Pulsed                       | L=0.5mH                             | 1320***    | mJ     |

Note: \* Repetitive rating; pulse width limited by junction temperature
\*\* Drain current is limited by junction temperature

## **Electrical Characteristics** $(T_c = 25^{\circ}C \text{ Unless Otherwise Noted})$

| Symbol                | Dorometer  | Parameter Test Conditions                         |     | HY3708 |      | I I a ! 4 |
|-----------------------|--|---|-----|--------|------|-----------|
| Symbol                | Parameter  |   |     | Тур.   | Max. | Unit      |
| Static Cha            | racteristics                                     |   | •   |        |      |           |
| BV <sub>DSS</sub>     | Drain-Source Breakdown Voltage                   | V <sub>GS</sub> =0V, I <sub>DS</sub> =250μA       | 80  | -      | -    | V         |
|                       | Zoro Coto Voltago Drain Current                  | V <sub>DS</sub> =80V, V <sub>GS</sub> =0V         | -   | -      | 1    |           |
| I <sub>DSS</sub>      | I <sub>DSS</sub> Zero Gate Voltage Drain Current | T <sub>J</sub> =85°C                              | -   | -      | 10   | μΑ        |
| V <sub>GS(th)</sub>   | Gate Threshold Voltage                           | $V_{DS}=V_{GS}$ , $I_{DS}=250$ μA                 | 2.0 | 3.0    | 4.0  | V         |
| I <sub>GSS</sub>      | Gate Leakage Current                             | $V_{GS}$ =±25V, $V_{DS}$ =0V                      | -   | -      | ±100 | nA        |
| R <sub>DS(ON)</sub> * | Drain-Source On-state Resistance                 | V <sub>GS</sub> =10V, I <sub>DS</sub> =85A        | -   | 3.6    | 4.5  | mΩ        |
| Diode Cha             | Diode Characteristics                            |   |     |        |      |           |
| V <sub>SD</sub> *     | Diode Forward Voltage                            | I <sub>SD</sub> =85 A, V <sub>GS</sub> =0V        | -   | 0.8    | 1.2  | V         |
| t <sub>rr</sub>       | Reverse Recovery Time                            | 05 A dl /dt 100 A /                               | -   | 30     | -    | ns        |
| Q <sub>rr</sub>       | Reverse Recovery Charge                          | l <sub>SD</sub> =85A, dl <sub>SD</sub> /dt=100A/μ | -   | 52     | -    | nC        |

<sup>\*\*\*</sup> VD=64V



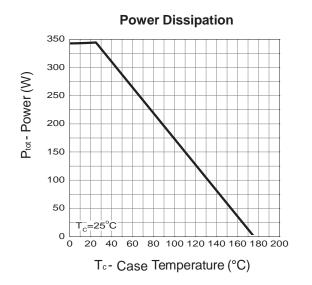
# **Electrical Characteristics (Cont.)** $(T_c = 25^{\circ}C \text{ Unless Otherwise Noted})$

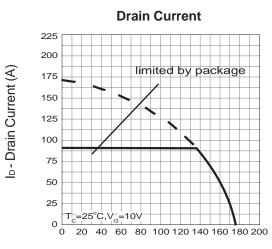
| Symbol                      | Parameter                       | Test Conditions  | HY3708 |      |      | Unit  |
|-----------------------------|---------------------------------|--|--------|------|------|-------|
| Symbol                      | ymbol rarameter rest conditions |  | Min.   | Тур. | Max. | Offic |
| Dynamic (                   | Characteristics                 |  |        |      |      |       |
| R <sub>G</sub>              | Gate Resistance                 | V <sub>GS</sub> =0V,V <sub>DS</sub> =0V,F=1MHz                     | -      | 1.8  | -    | Ω     |
| C <sub>iss</sub>            | Input Capacitance               | $V_{GS}=0V$ ,  | -      | 6410 | -    |       |
| C <sub>oss</sub>            | Output Capacitance              | V <sub>DS</sub> =25V,  | -      | 995  | -    | pF    |
| C <sub>rss</sub>            | Reverse Transfer Capacitance    | Frequency=1.0MHz   | -      | 530  | -    |       |
| t <sub>d(ON)</sub>          | Turn-on Delay Time              |  | -      | 28   | -    |       |
| Tr                          | Turn-on Rise Time               | $V_{DD}$ =40V, $R_{G}$ =6 $\Omega$ , $I_{DS}$ =85A, $V_{GS}$ =10V, | -      | 18   | -    | ns    |
| t <sub>d(OFF)</sub>         | Turn-off Delay Time             |  | -      | 42   | -    | 115   |
| T <sub>f</sub>              | Turn-off Fall Time              |  | -      | 54   | -    |       |
| Gate Charge Characteristics |                                 |  |        |      |      |       |
| Qg                          | Total Gate Charge               | .,,  | -      | 154  | -    |       |
| Q <sub>gs</sub>             | Gate-Source Charge              | $V_{DS}$ =64V, $V_{GS}$ =10V, $V_{DS}$ =85A                        | -      | 25   | -    | nC    |
| $Q_{gd}$                    | Gate-Drain Charge               | 103 3311   | -      | 53   | -    |       |

Note \* : Pulse test ; pulse width  $\leq\!300\mu s,$  duty cycle  $\leq\!2\%.$ 

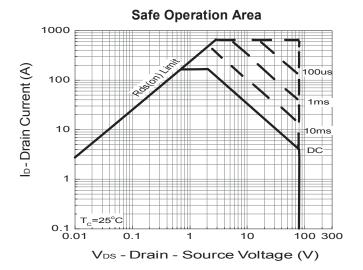


## **Typical Operating Characteristics**

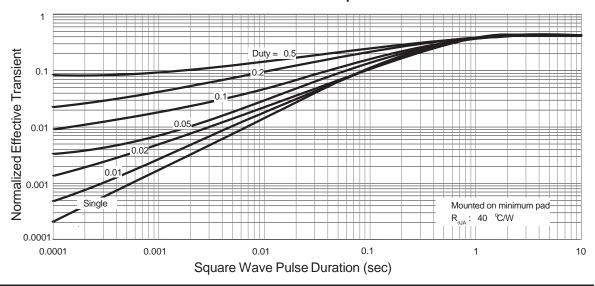




T<sub>c</sub>-Case Temperature (°C)

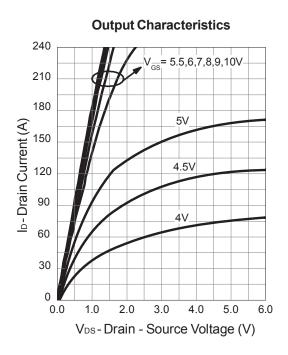


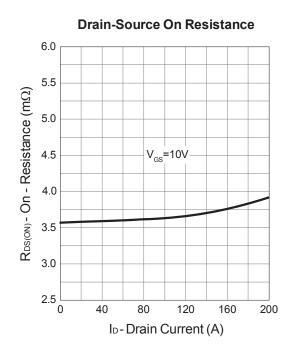
#### **Thermal Transient Impedance**

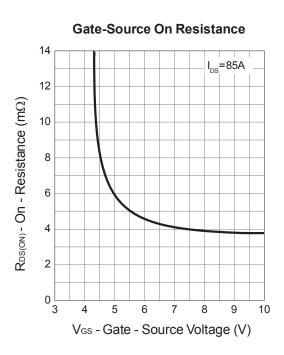


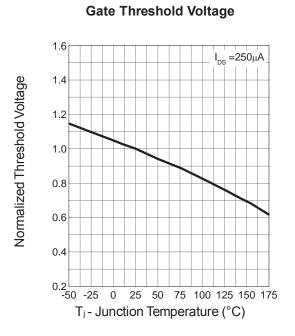


## **Typical Operating Characteristics (Cont.)**





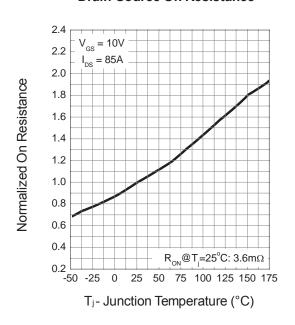




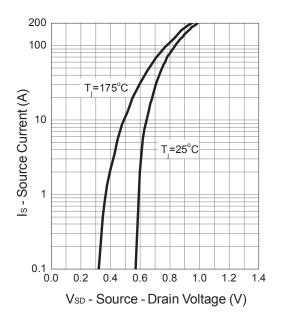


## **Typical Operating Characteristics (Cont.)**

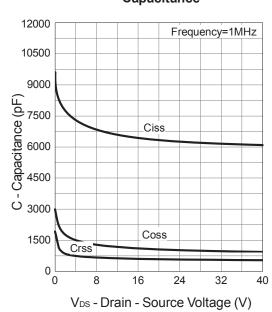
### **Drain-Source On Resistance**



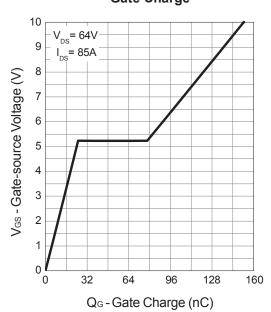
#### Source-Drain Diode Forward



#### Capacitance

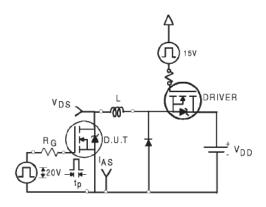


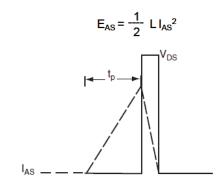
### **Gate Charge**



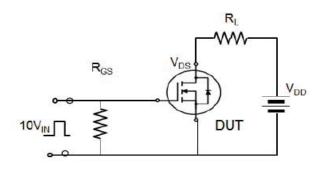


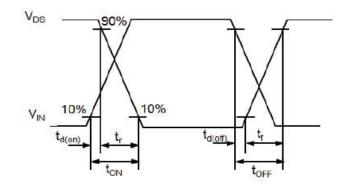
### **Avalanche Test Circuit**



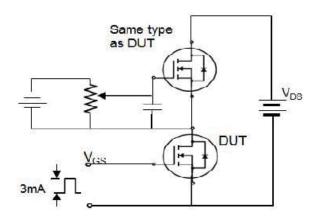


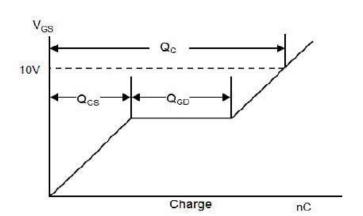
## **Switching Time Test Circuit**





## **Gate Charge Test Circuit**





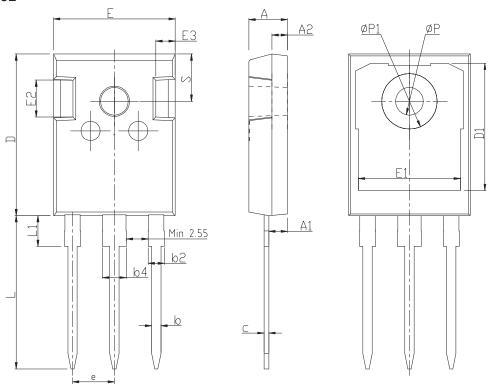


### **Device Per Unit**

| Package Type | Unit | Quantity |
|--------------|------|----------|
| TO-247A-3L   | Tube | 30       |

# Package Information

### TO-247A-3L



COMMON DIMENSIONS

| CAMDOI |          | mm       |        |
|--------|----------|----------|--------|
| SYMBOL | MIN      | NOM      | MAX    |
| A      | 4.80     | 5.00     | 5. 20  |
| A1     | 2. 21    | 2.41     | 2.61   |
| A2     | 1.85     | 2.00     | 2. 15  |
| b      | 1.11     | 1.21     | 1.36   |
| b2     | 1.91     | 2.01     | 2.21   |
| b4     | 2.91     | 3. 01    | 3. 21  |
| С      | 0.51     | 0.61     | 0.75   |
| D      | 20.70    | 21.00    | 21.30  |
| D1     | 16. 25   | 16.55    | 16.85  |
| Е      | 15.50    | 15.80    | 16. 10 |
| E1     | 13.00    | 13.30    | 13.60  |
| E2     | 4.80     | 5.00     | 5. 20  |
| E3     | 2.30     | 2.50     | 2.70   |
| е      |          | 5. 44BSC |        |
| L      | 19.62    | 19.92    | 20.22  |
| L1     | _        | -        | 4.30   |
| Р      | 3.40     | 3.60     | 3.80   |
| P1     | _        | _        | 7.30   |
| S      | 6. 15BSC |          |        |

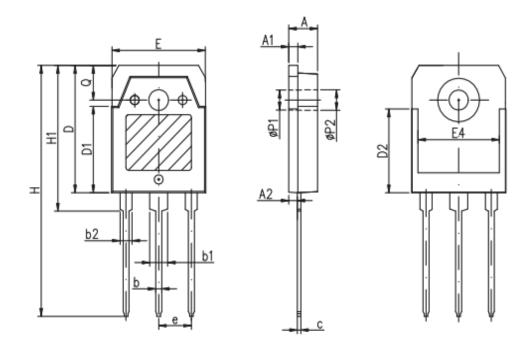


## **Device Per Unit**

| Package Type | Unit | Quantity |
|--------------|------|----------|
| TO-3P-3L     | Tube | 30       |

## **Package Information**

TO-3P-3L

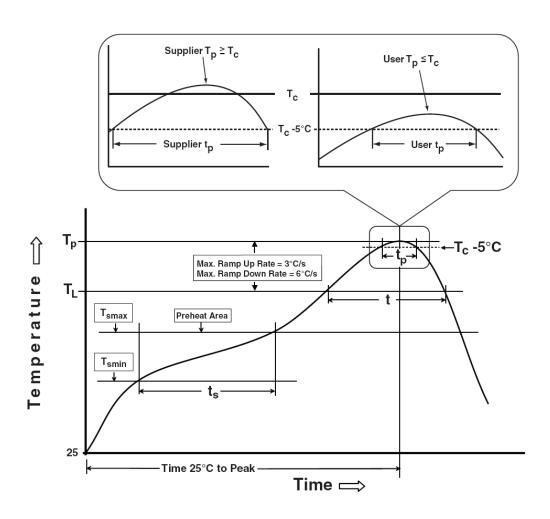


COMMON DIMENSIONS

| SYMBOL |        | mm     |        |
|--------|--------|--------|--------|
| SIMDUL | MIN    | NOM    | MAX    |
| A      | 4.60   | 4.80   | 5.00   |
| A1     | 1.40   | 1.50   | 1.65   |
| A2     | 1.18   | 1.38   | 1.58   |
| b      | 0.80   | 1.00   | 1.20   |
| b1     | 2.80   | 3.00   | 3. 20  |
| b2     | 1.80   | 2.00   | 2.20   |
| c      | 0.50   | 0.60   | 0.75   |
| D      | 19.60  | 19.90  | 20. 20 |
| D1     | 13. 55 | 13. 90 | 14. 25 |
| D2     |        | 12.90  | REF    |
| Е      | 15. 35 | 15.60  | 15. 85 |
| E4     | 12.60  | -      | _      |
| e      |        | 5.45   | TYP    |
| Н      | 40.10  | 40.50  | 40. 90 |
| H1     | 23. 15 | 23. 40 | 23. 65 |
| ФР1    |        | 3. 20  | REF    |
| ФР2    |        | 3.50   | REF    |



### **Classification Profile**



### **Classification Reflow Profiles**

| Profile Feature   | Sn-Pb Eutectic Assembly            | Pb-Free Assembly                   |  |
|---|------------------------------------|------------------------------------|--|
| Preheat & Soak Temperature min (T <sub>smin</sub> ) Temperature max (T <sub>smax</sub> ) Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> ) | 100 °C<br>150 °C<br>60-120 seconds | 150 °C<br>200 °C<br>60-120 seconds |  |
| Average ramp-up rate (T <sub>smax</sub> to T <sub>P</sub> )   | 3 °C/second max.                   | 3°C/second max.                    |  |
| Liquidous temperature (T <sub>L</sub> ) Time at liquidous (t <sub>L</sub> )   | 183 °C<br>60-150 seconds           | 217 °C<br>60-150 seconds           |  |
| Peak package body Temperature (T <sub>p</sub> )*  | See Classification Temp in table 1 | See Classification Temp in table 2 |  |
| Time (t <sub>P</sub> )** within 5°C of the specified classification temperature (T <sub>c</sub> )   | 20** seconds                       | 30** seconds                       |  |
| Average ramp-down rate (T <sub>p</sub> to T <sub>smax</sub> )   | 6 °C/second max.                   | 6 °C/second max.                   |  |
| Time 25°C to peak temperature   | 6 minutes max.                     | 8 minutes max.                     |  |
| * Tolerance for peak profile Temperature (T ) is defined as a supplier minimum and a user maximum   |                                    |                                    |  |

Tolerance for peak profile Temperature  $(T_p)$  is defined as a supplier minimum and a user maximum. Tolerance for time at peak profile temperature  $(t_p)$  is defined as a supplier minimum and a user maximum.



Table 1. SnPb Eutectic Process – Classification Temperatures (Tc)

| Package<br>Thickness | Volume mm <sup>3</sup><br><350 | Volume mm³<br>≥350 |
|----------------------|--------------------------------|--------------------|
| <2.5 mm              | 235 °C                         | 220 °C             |
| ≥2.5 mm              | 220 °C                         | 220 °C             |

Table 2. Pb-free Process – Classification Temperatures (Tc)

| Package         | Volume mm <sup>3</sup> | Volume mm <sup>3</sup> | Volume mm <sup>3</sup> |
|-----------------|------------------------|------------------------|------------------------|
| Thickness       | <350                   | 350-2000               | >2000                  |
| <1.6 mm         | 260 °C                 | 260 °C                 | 260 °C                 |
| 1.6 mm – 2.5 mm | 260 °C                 | 250 °C                 | 245 °C                 |
| ≥2.5 mm         | 250 °C                 | 245 °C                 | 245 °C                 |

### **Reliability Test Program**

| Test item     | Method        | Description                              |
|---------------|---------------|--|
| SOLDERABILITY | JESD-22, B102 | 5 Sec, 245°C                             |
| HTRB          | JESD-22, A108 | 168 Hrs /500 Hrs /1000 Hrs, Bias @ 150°C |
| PCT           | JESD-22, A102 | 96Hrs, 100%RH, 2atm, 121°C               |
| TCT           | JESD-22, A104 | 500 Cycles, -55°C~150°C                  |

#### **Customer Service**

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